

What is NAND Flash Memory?

March '03

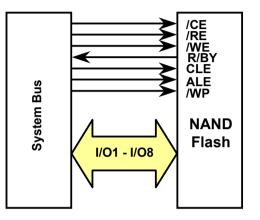
File Memory Marketing & Promotion Department Memory Division TOSHIBA Semiconductor Company

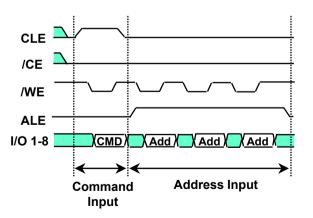
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TOSHIBA NAND Flash Memory Concept

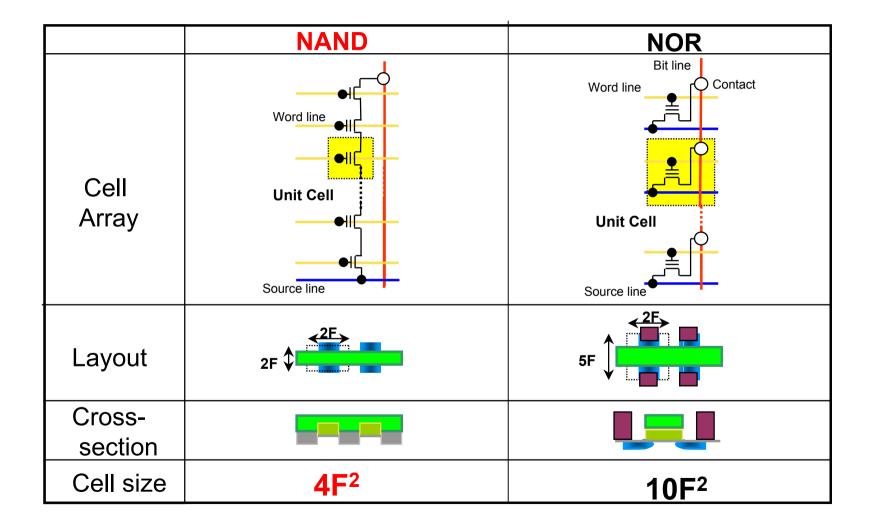
Suitable for file storage

- File memory architecture
- Page programming (512 bytes/page)
- High performance
 - High speed programming and erasing
- Low cost
 - Small chip size based on NAND Structure
 - Small pin count
- Easy memory expansion
 - Simple interface by command control





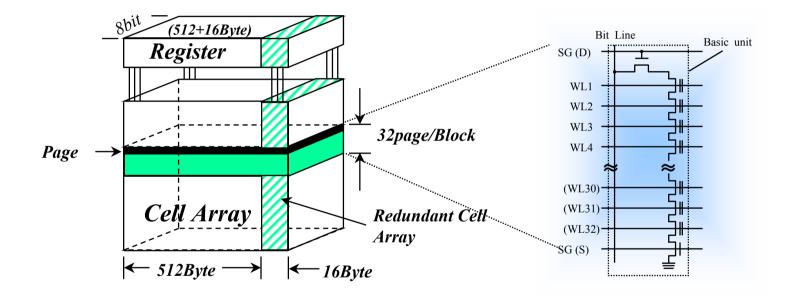




	NAND	NOR
Capacity	~ 1Gbit (2chips/pkg)	~ 128Mbit
Power Supply	2.7-3.6V	2.3-3.6V
I/O	x 8	x8/x16
Access Time	50ns(serial access cycle) 25μs(random access)	70ns(30pF, 2.3V) 65ns(30pF, 2.7V)
Program Speed (typ.)		8μs/Byte
	200μs/512Byte	4.1ms/512Byte
Erase Speed(typ.)	2ms/Block (16KB)	700ms/Block
Prog+Erase(typ.)	33.6ms / 64КВ	1.23s/Block (main:64KB)

TOSHIBA NAND Flash Memory Block Diagram

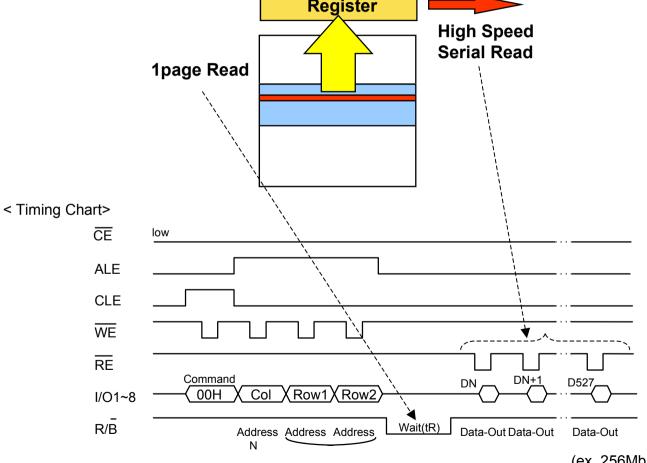
ex.256Mb NAND Flash Memory



256Mb NAND Flash Page Size : 512+16 Bytes Block Size : 16KBytes # of Blocks : 2048 Blocks

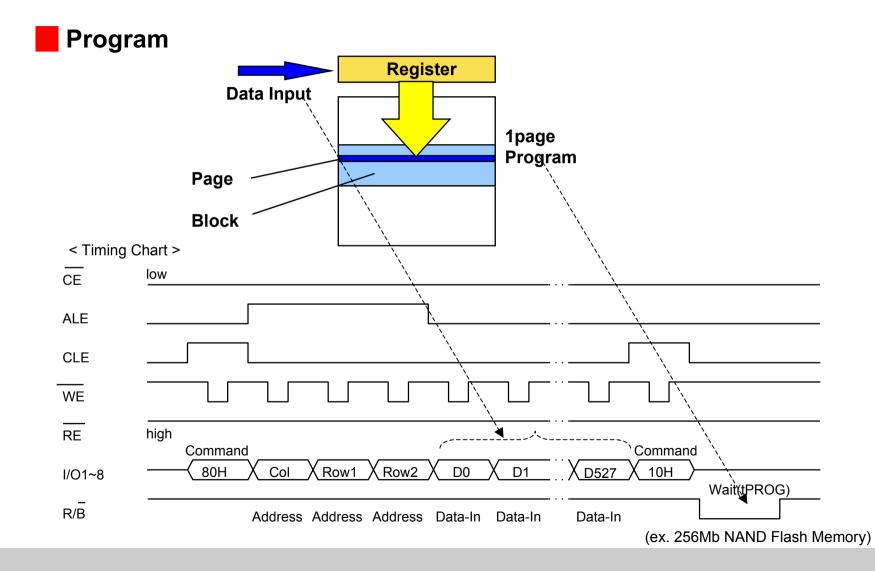
 Read
 Register
 High Speed

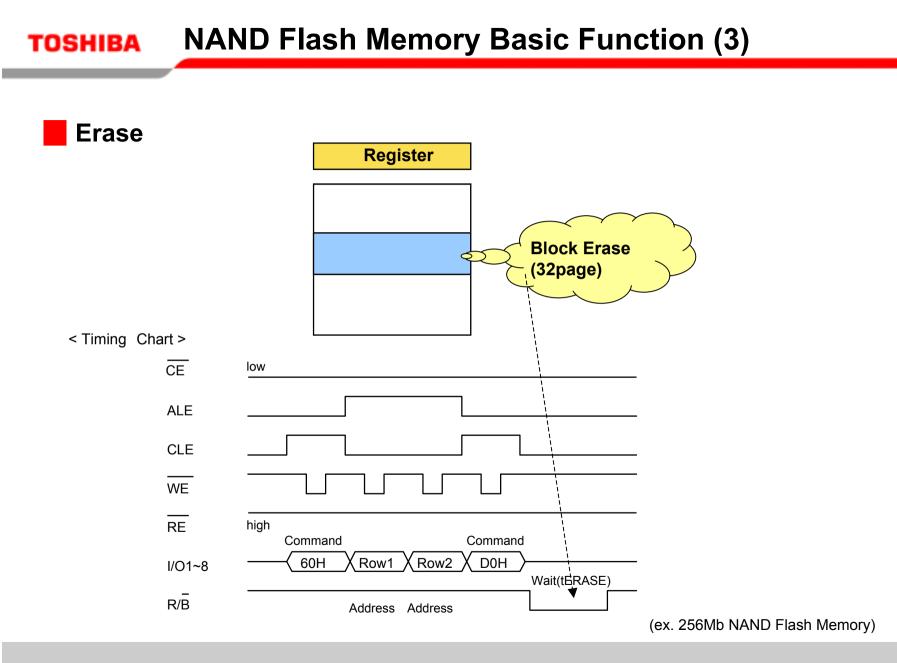
 Serial Read
 Annue Read



(ex. 256Mb NAND Flash Memory)

TOSHIBA NAND Flash Memory Basic Function (2)







< Required Items >

1. NAND Flash File Management

- Bad Block Management
- Wear Leveling Treatment

2. ECC Support

- 1 bit/page error correction and 2bit/page error detection**

* ECC : Error Correction Code

* * : 2LC NAND Flash 1bit/page ECC

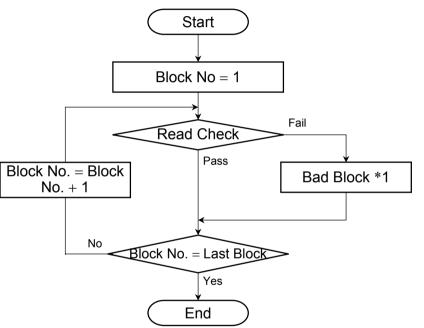
Number of valid blocks at shipping

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Туре.	Min.	Max.	
TC58V64	1014	1024	
TC58128	1004	1024	
TC58256	2008	2048	
TC58512	4016	4096	
TH58100	8032	8192	

Invalid blocks have to be detected by bad block test flow before erasing.

- Invalid block : include "0" data. This "0" data may be lost by erasing.
- Valid block : has only "1" data.



< Read Check >

Read the 1st page of each block. If byte 517 of the 1st page is not FF (Hex), define the block as a bad block. The 1st block in the device is guaranteed to be good at time of shipment.

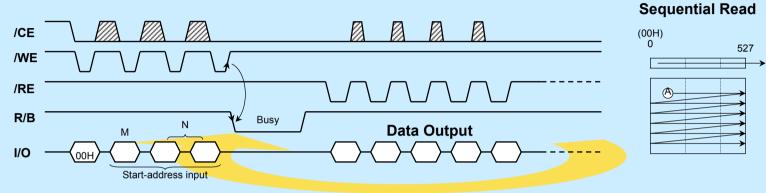
*1 : No erase operation is allowed to bad blocks



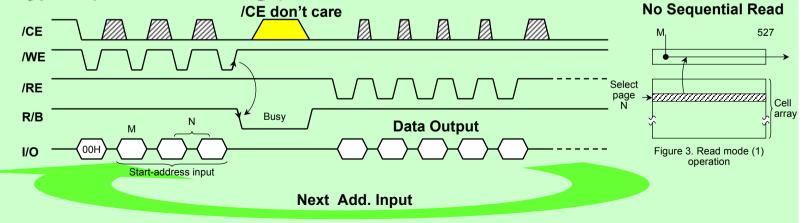
	0.16um				
	TC58V64BFT	TC58128AFT	TC58256AFT	TC58512FT	TH58100FT
	64Mb	128Mb	256Mb	512Mb	1Gb
Density	(8M+256K)x8	(16M+512K)x8	(32M+1M)x8	(64M+2M)x8	(128M+4M)x8
Operation voltage	2.7V-3.6V	←	←	←	←
Page size (program unit)	512B+16B	←	←	←	←
Block size (erase unit)	8KB+256B	16KB+512B	←	←	←
Number of Pages per Block	16	32	←	←	←
Number of Blocks	1024	1024	2048	4096	8192
Number of Address cycle	3	←	←	4	←
Random access time (us)	25us (max.)				
Serial access time (ns)	50ns (min.)				
Package	400mil / 0.8mm TSOP type II TSOP I 48-P-1220-0.50				

TOSHIBA 2 Type Read Function

Type 1 (TSOP Package)

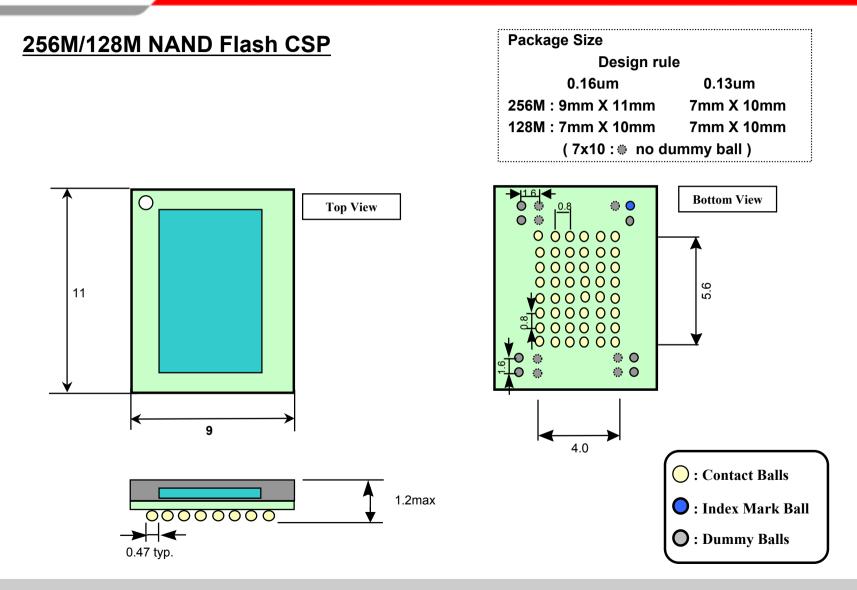


Type 2 (BGA/MCP Package)



Package Typ	be	TSOP-II 44-P-400-0.8	TSOP-I 48-P-1220-0.50	
Top View		$V_{SS} = 1 + 44 + V_{CC}$ $CLE = 2 + 43 + CCE + 22 + 43 + CCE + 24 + 44 + 41 + R/B + R/B + R/B + R/B + 10 + 0P + 10 + 10 + 10 + 10 + 10 + 10$	NCC 48 NCC 48 NCC NCC NCC 100 445 1007 12 3 445 1007 12 445 100 445 100 1007 1100 1007 1100 1007 1100 1007 1100 1007 11100 1007 11100 1007 11100 1007 11100 1007 11100 1007 11100 1007 111100 1007 111100 1007 111100 1007 111100 1002 11111100 1002 1111111111 1002 1111111111111 1002 111111111111111 1002 11111111111111111111 1002 111111111111111111111111111111111111	
Package dimensions & Close	Single	18.41(L) x 11.76(W) x 1.2 _(max) mm 64Mbit : TC58V64BFT	12.0(L) x 20.0(W) x 1.2 _(max) mm 128Mbit : TC58128AFT 256Mbit : TC58256AFT 512Mbit : TC58512FT	
section View & Memory P/N	Stacked		12.0(L) x 20.0(W) x 1.2 _(max) mm 1Gbit : TH58100FT	

TOSHIBA CSP Outline Drawing



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